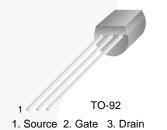
November 2013



2N7000BU / 2N7000TA Advanced Small-Signal MOSFET

Features

- Fast Switching Times
- Improved Inductive Ruggedness
- Lower Input Capacitance
- Extended Safe Operating Area
- Improved High-Temperature Reliability



Description

These N-channel enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. These products minimize onstate resistance while providing rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 400 mA DC and can deliver pulsed currents up to 2 A. These products are particularly suited for low-voltage, low-current applications, such as small servo motor control, power MOSFET gate drivers, and other switching applications.

Ordering Information

Part Number	Marking	Package	Packing Method
2N7000BU	2N7000	TO-92 3L	Bulk
2N7000TA	2N7000	TO-92 3L	Ammo

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_{\rm C} = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit	
V _{DSS}	Drain-to-Source Voltage	60	V	
Continuous Drain Current (T _C = 25°C)		200	mA	
Ι _D	Continuous Drain Current (T _C = 100°C)	110	- mA	
I _{DM}	Drain Current Pulsed ⁽¹⁾	1000	mA	
V _{GS}	Gate-to-Source Voltage	±30	V	
T _{J,} T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150	°C	
ΤL	Maximum Lead Temperature for Soldering Purposes, 1/8-inch from Case for 5 Seconds	300	°C	

Note:

1. Repetitive rating: pulse width limited by maximum junction temperature.

Thermal Characteristics⁽²⁾

Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Value	Unit
р	Total Power Dissipation (T _C = 25°C)	400	mW
PD	Linear Derating Factor	3.2	mW/°C
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	312.5	°C/W

Note:

2. Device mounted on FR-4 PCB, board size = 101.5 mm x 114.5 mm.

Electrical Characteristics

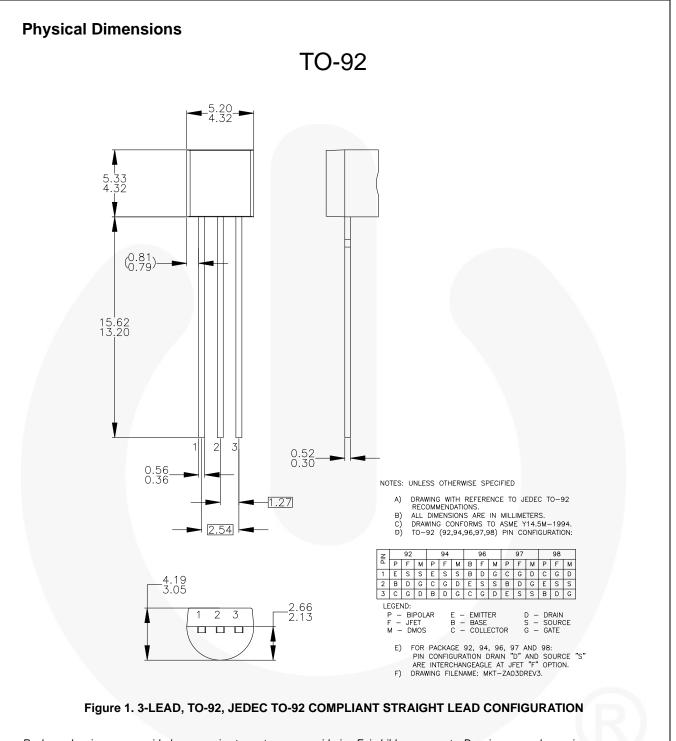
Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	60			V
N	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.3		3.9	V
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	0.4		2.2	
1	Gate-Source Leakage, Forward	V _{GS} = 15 V			100) nA
I _{GSS}	Gate-Source Leakage, Reverse	V _{GS} = -15 V			-100	114
1	Drain-to-Source Leakage Current	V _{DS} = 60 V			1	μA
I _{DSS}		$V_{DS} = 45 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			1000	μA
R _{DS(ON)}	Static Drain-Source On-State Resistance ⁽³⁾	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$			5.0	Ω
9 _{fs}	Forward Transconductance ⁽³⁾	V _{DS} = 15 V, I _D = 0.5 A	0.1	0.3		S
C _{iss}	Input Capacitance			30		pF
C _{oss}	Output Capacitance	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz$		12		pF
C _{rss}	Reverse Transfer Capacitance			3.0		pF
t _{d(on)}	Turn-On Delay				10	ns
t _r	Rise Time	$V_{DD} = 30 V, I_{D} = 0.5 A,$			10	ns
t _{d(off)}	Turn-Off Delay	$R_{G} = 15 \Omega^{(3),(4)}$		_	10	ns
t _f	Fall Time				10	ns

Notes:

3. Pulse test: pulse width = 250 $\mu s,$ duty cycle \leq 2%.

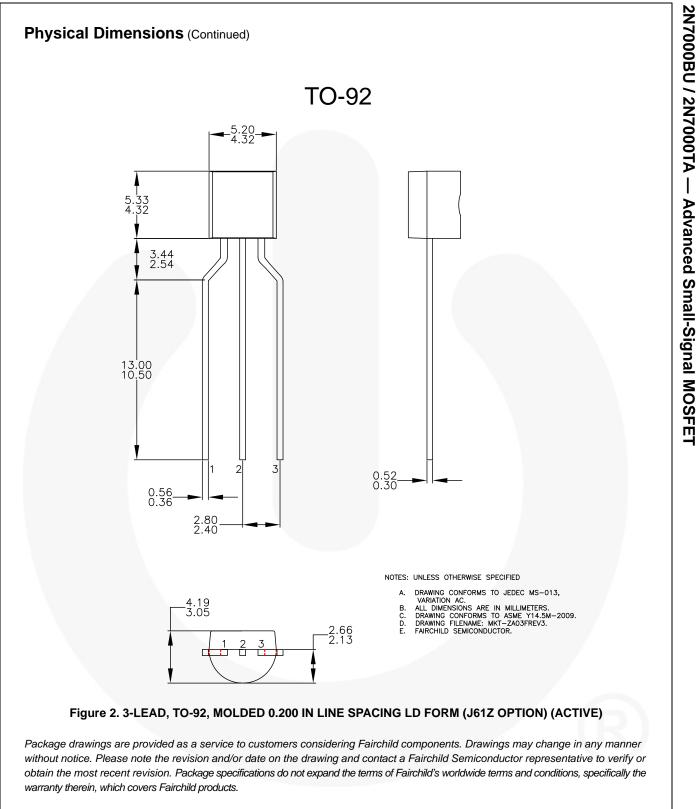
4. Essentially independent of operating temperature.



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Definition of	Terms
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Datasheet Identification	Product Status	Definition
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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